Advanced Load Management Switch

FPF1504 / FPF1504L

Description

The FPF1504/FPF1504L are low−R_{DS} P−channel MOSFET load switches of the IntelliMAX™ family. Integrated slew−rate control prevents excessive inrush current from the supply rails with capacitive loads common in power applications. In addition, the FPF1504/FPF1504L feature output discharge capability.

The input voltage range operates from 1.0 V to 3.6 V to fulfill today's mobile device supply requirements. Switch control is by a logic input (ON pin) capable of interfacing directly with low−voltage CMOS control signals and GPIOs in embedded processors.

Features

- 1.0 V to 3.6 V Input Voltage Operating Range
- Typical $R_{DS(ON)}$:
  - 15 mΩ at V_{IN} = 3.3 V
  - 20 mΩ at V_{IN} = 1.8 V
  - 40 mΩ at V_{IN} = 1.0 V
- Slew Rate Control
- Output Discharge Function
- Low <1 μA Quiescent Current at V_{ON} = V_{IN}
- ESD Protected: 4000 V HBM, 2000 V CDM
- GPIO/CMOS−Compatible Enable Circuitry
- Active HIGH and active LOW versions

Applications

- Mobile Devices and Smart Phones
- Portable Media Devices
- Digital Cameras
- Advanced Notebook, UMPC, and MID
- Portable Medical Devices
- GPS and Navigation Equipment

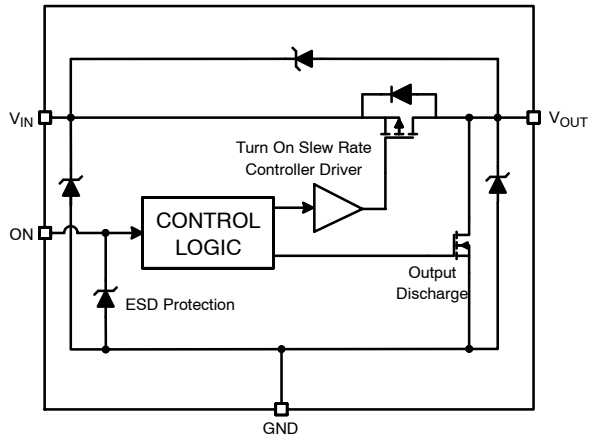


Figure 1. Block Diagram

ON Semiconductor®

www.onsemi.com

WLCSP4
CASE 567RH

MARKING DIAGRAM

G	= 1st Digit of 2 Digit Device ID Mark
&K	= 2−Digits Lot Run Traceability Code
4	= 2nd Digit of 2 Digit Device ID Mark
&2	= 2−digit Date Code Format
&.	= Pin 1 Identifier
&E	= Space Designator
&Z	= Assembly Plant Code

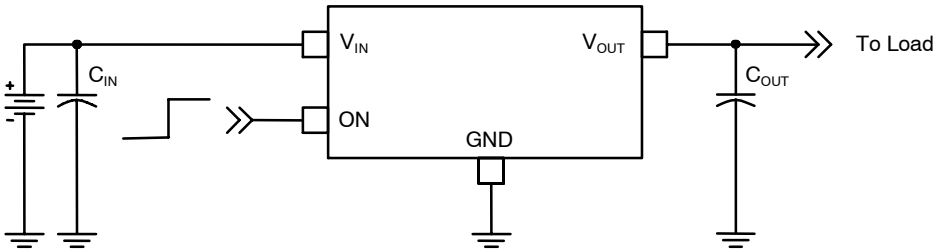
ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

ORDERING INFORMATION

Part Number	Top Mark	Switch (Typical) At 1.8 V_{IN}	Input Buffer	Output Discharge	ON Pin Activity	Package
FPF1504UCX	G4	20 mΩ	CMOS	YES	Active HIGH	4−Ball, WLCSP, 0.5 mm Pitch
FPF1504BUCX	G4	20 mΩ	CMOS	YES	Active HIGH	4−Ball, WLCSP with Backside Laminate, 0.5 mm Pitch
FPF1504LUCX	GZ	20 mΩ	CMOS	YES	Active LOW	4−Ball, WLCSP, 0.5 mm Pitch
FPF1504LBUCX	GZ	20 mΩ	CMOS	YES	Active LOW	4−Ball, WLCSP with Backside Laminate, 0.5 mm Pitch

Application Diagram



NOTES: 1. C_{IN} =1 μF, X5R, 0603, for example Murata GRM185R60J105KE26.
2. C_{OUT} = 1 μF, X5R, 0805, for example Murata GRM216R61A105KA01.

Figure 2. Typical Application

Pin Configurations

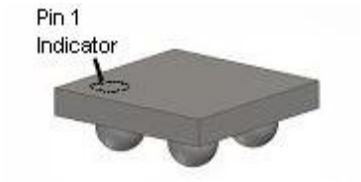


Figure 3. 1 x 1 mm WLCSP Bumps Facing Down

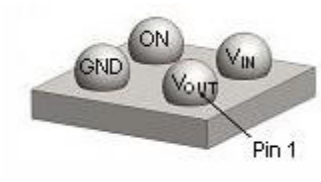


Figure 4. 1 x 1 mm WLCSP Bumps Facing Up

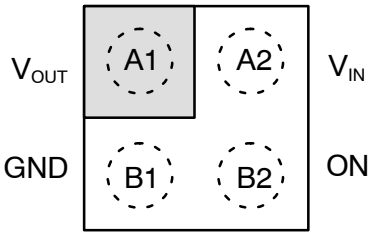


Figure 5. Pin Assignments (Top View)

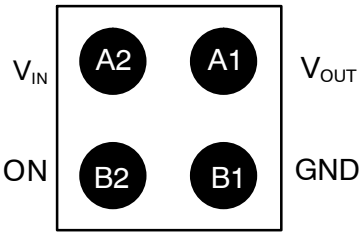


Figure 6. Pin Assignments (Bottom View)

PIN DEFINITIONS

Pin #	Name	Description
A1	V_{OUT}	Switch Output
A2	V_{IN}	Supply Input; Input to the Power Switch
B1	GND	Ground
B2	ON	ON/OFF Control

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter		Min.	Max.	Unit
V_{IN}	V_{IN}, V_{OUT}, V_{ON} to GND		−0.3	4.0	V
I_{SW}	Maximum Continuous Switch Current			1.5	A
P_D	Power Dissipation at T_A = 25°C			1.0	W
T_{STG}	Storage Junction Temperature		−65	+150	°C
T_A	Operating Temperature Range		−40	+85	°C
θ_{JA}	Thermal Resistance, Junction−to−Ambient	1S2P with 1 Thermal Via		95	°C/W
		1S2P without Thermal Via		187	
ESD	Electrostatic Discharge Capability	Human Body Model, JESD22−A114	4		kV
		Charged Device Model, JESD22−C101	2		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min.	Max.	Unit
V_{IN}	Supply Voltage	1.0	3.6	V
T_A	Ambient Operating Temperature	−40	+85	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

ELECTRICAL CHARACTERISTICS

Unless otherwise noted, V_{IN} = 1.0 to 3.6 V, T_A = −40 to +85°C; Typical Values are at V_{IN} = 3.3 V and T_A = 25°C.

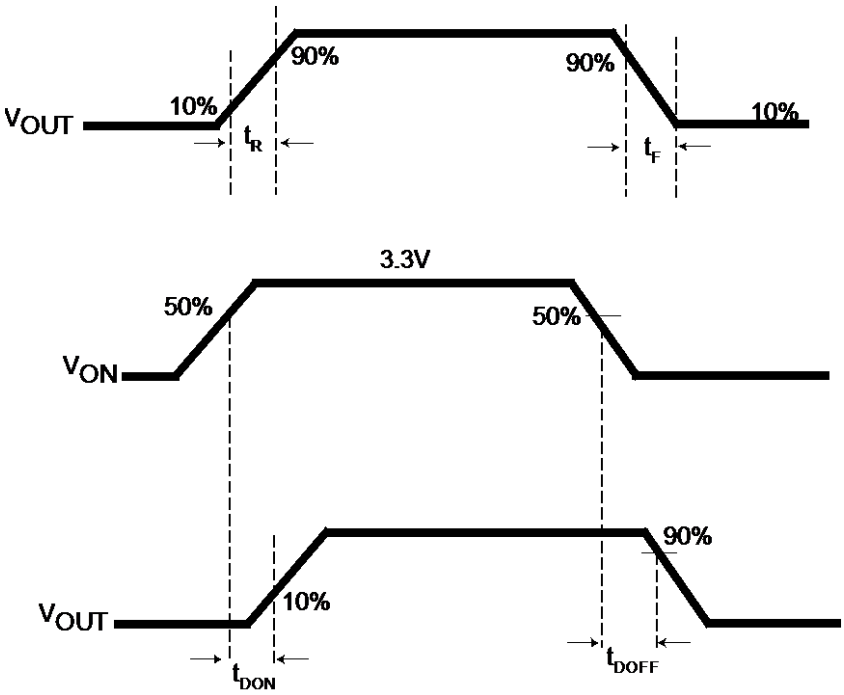
Symbol	Parameter		Conditions	Min.	Typ.	Max.	Units
BASIC OPERATION							
V_{IN}	Supply Voltage			1.0		3.6	V
$I_{Q(OFF)}$	Off Supply Current	FPF1504	V_{ON} = GND, V_{OUT} = Open		0.25		μA
		FPF1504L	V_{ON} = V_{IN}, V_{OUT} = Open		0.3		
$I_{SD(OFF)}$	Off Switch Current	FPF1504	V_{ON} = GND, V_{OUT} = GND		0.25		
		FPF1504L	V_{ON} = V_{IN}, V_{OUT} = GND		0.3		
I_Q	Quiescent Current	FPF1504	I_{OUT} = 0 mA, V_{IN} = 3.6 V, V_{ON} = V_{IN}		0.08		
			I_{OUT} = 0 mA, V_{ON} = $V_{IH(MIN)}$		0.75		
		FPF1504L	I_{OUT} = 0 mA, V_{IN} = 3.6 V, V_{ON} = GND		0.08		
			I_{OUT} = 0 mA, V_{ON} = $V_{IL(MAX)}$		0.95		
R_{ON}	On Resistance		V_{IN} = 3.3 V, I_{OUT} = 200 mA, T_A = 25°C		15	30	mΩ
			V_{IN} = 1.8 V, I_{OUT} = 200 mA, T_A = 25°C		20	40	
			V_{IN} = 1.5 V, I_{OUT} = 200 mA, T_A = 25°C		30		
			V_{IN} = 1.0 V, I_{OUT} = 200 mA, T_A = 25°C		40	80	
			V_{IN} = 1.8 V, I_{OUT} = 200 mA, T_A = 85°C (Note 3)		35	50	
R_{PD}	Output Discharge Pull−Down Resistance		V_{ON} = 0 V or V_{IN}, I_{OUT} = −20 mA		65	95	Ω
V_{IH}	On Input Logic High Voltage	FPF1504		0.8			V
V_{IL}	On Input Logic Low Voltage	FPF1504				0.3	
I_{ON}	On Input Leakage		V_{ON} = V_{IN} or GND			1	μA
DYNAMIC CHARACTERISTICS							
t_{DON}	Turn−On Delay (Note 4)	FPF1504	R_L = 10 Ω, C_L = 0.1 μF, V_{IN} = 3.3 V, T_A = 25°C		80		μs
t_R	V_{OUT} Rise Time (Note 4)	FPF1504			130		
t_{ON}	Turn−On Time (Note 4)	FPF1504			210		
t_{DON}	Turn−On Delay (Note 4)	FPF1504	R_L = 500 Ω, C_L = 0.1 μF, V_{IN} = 3.3 V, T_A = 25°C		70	100	μs
		FPF1504L			95		
t_R	V_{OUT} Rise Time (Note 4)	FPF1504			110	150	
		FPF1504L			115		
t_{ON}	Turn−On Time (Note 4)	FPF1504			180	250	
		FPF1504L			210		
t_{DOFF}	Turn−Off Delay (Note 4)	FPF1504	R_L=10 Ω, C_L = 0.1 μF, V_{IN} = 3.3 V, T_A = 25°C		25	30	μs
t_F	V_{OUT} Fall Time (Note 4)	FPF1504			2		
t_{OFF}	Turn−Off Time (Note 4)	FPF1504			27		

ELECTRICAL CHARACTERISTICS (continued)
Unless otherwise noted, V_{IN} = 1.0 to 3.6 V, T_A = −40 to +85°C; Typical Values are at V_{IN} = 3.3 V and T_A = 25°C.

Symbol	Parameter		Conditions	Min.	Typ.	Max.	Units
DYNAMIC CHARACTERISTICS							
t_{DOFF}	Turn−Off Delay (Note 4)	FPF1504	R_L = 500 Ω, C_L = 0.1 μF, V_{IN} = 3.3 V, T_A = 25°C		25		μs
		FPF1504L			2		
t_F	V_{OUT} Fall Time (Note 4)	FPF1504			12		
		FPF1504L			14		
t_{OFF}	Turn−Off Time (Note 4)	FPF1504			37		
		FPF1504L			16		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
3. This parameter is guaranteed by design and characterization; not production tested.
4. $t_{DON}/t_{DOFF}/t_R/t_F$ are defined in Figure 7.
5. Output discharge path is enabled during off.

Timing Diagram – FPF1504



NOTES: 6. $t_{ON} = t_R + t_{DON}$.
7. $t_{OFF} = t_F + t_{DOFF}$.

Figure 7. Timing Diagram for FPF1504

TYPICAL PERFORMANCE CHARACTERISTICS FOR FPF1504

Applicable to active high version only.

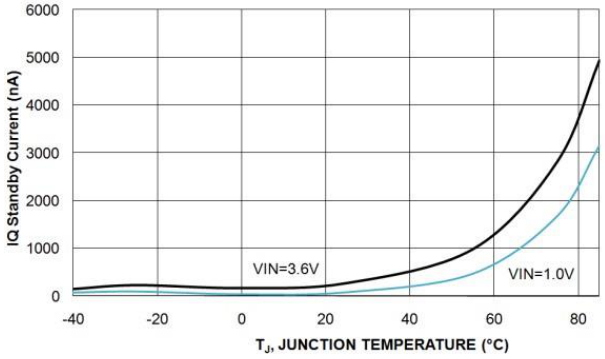


Figure 1. Shutdown Current vs. Temperature

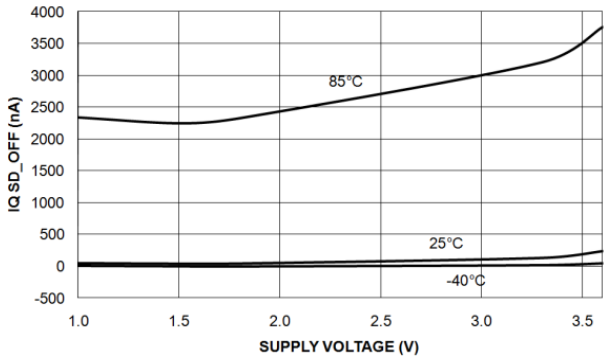


Figure 2. Shutdown Current vs. Supply Voltage

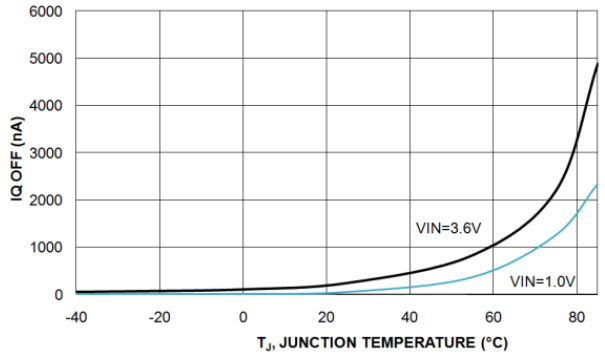


Figure 3. Off Supply Current vs. Temperature

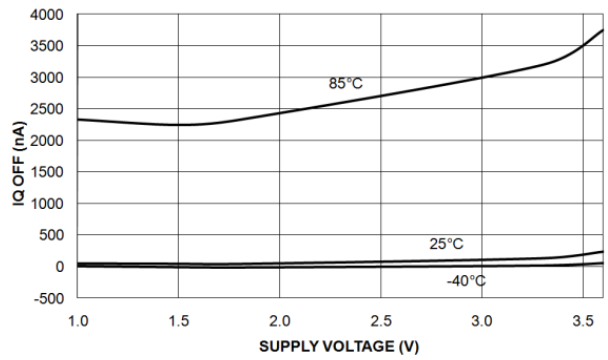


Figure 4. Off Supply Current vs. Supply Voltage

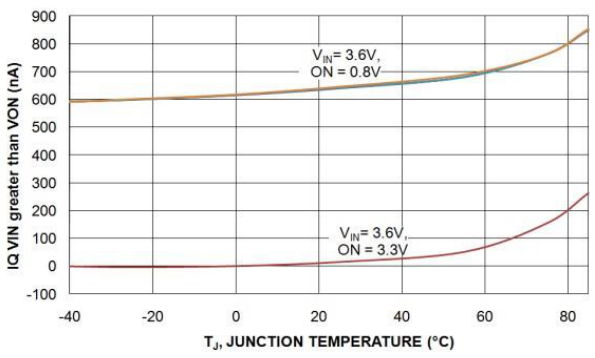


Figure 5. Quiescent Current vs. Temperature

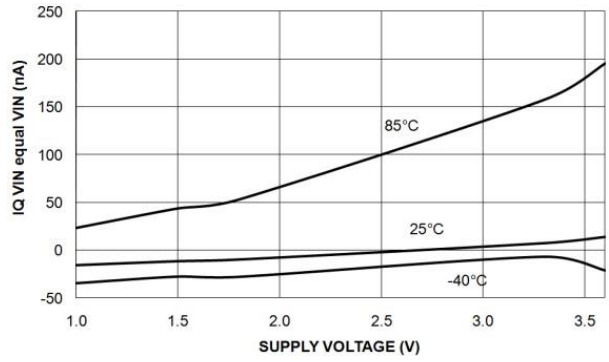


Figure 6. Quiescent Current vs. Supply Voltage (V_{ON} = V_{IN})

TYPICAL PERFORMANCE CHARACTERISTICS FOR FPF1504

Applicable to active high version only.

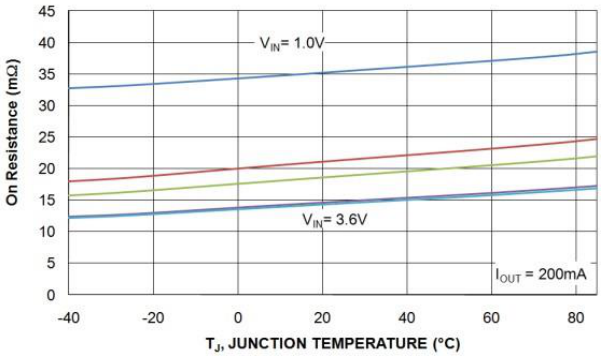


Figure 7. R_{ON} vs. Temperature

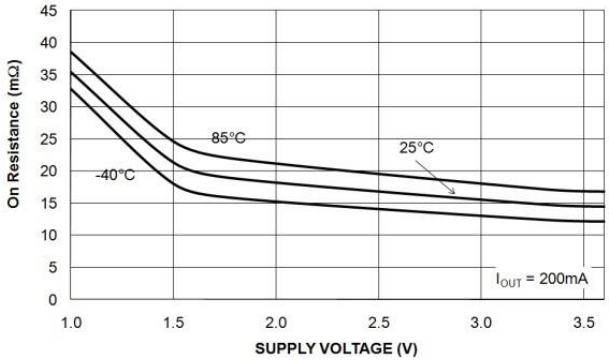


Figure 8. R_{ON} vs. Temperature

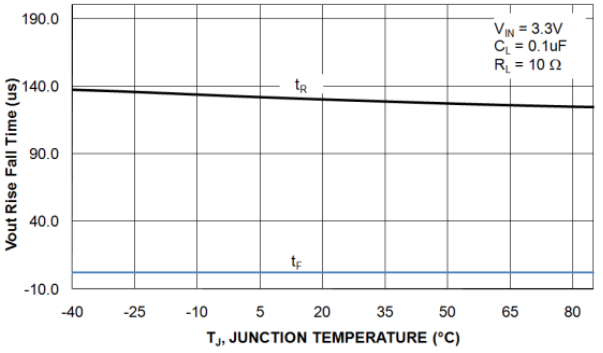


Figure 9. V_{OUT} Rise/Fall Times vs. Temperature (R_L = 10 Ω)

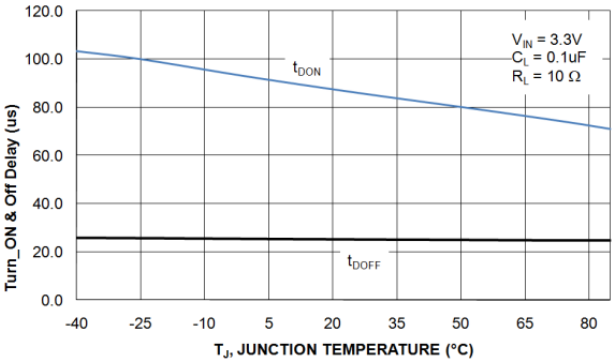


Figure 10. V_{OUT} Turn−On/Turn−Off Delays vs. Temperature (R_L = 10 Ω)

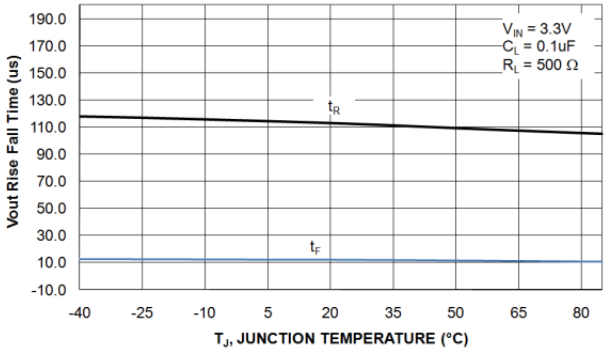


Figure 11. V_{OUT} Rise/Fall Time vs. Temperature (R_L = 500 Ω)

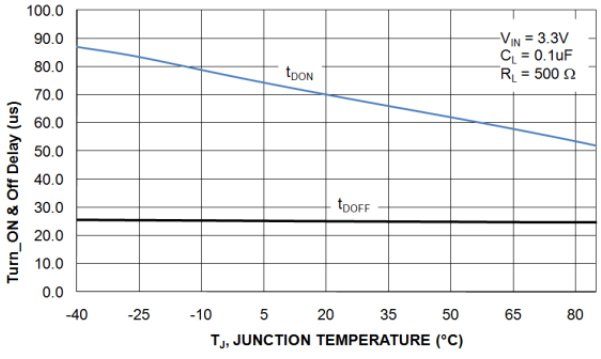


Figure 12. V_{OUT} Turn−On/Turn−Off Delays vs. Temperature (R_L = 500 Ω)

TYPICAL PERFORMANCE CHARACTERISTICS FOR FPF1504

Applicable to active high version only.

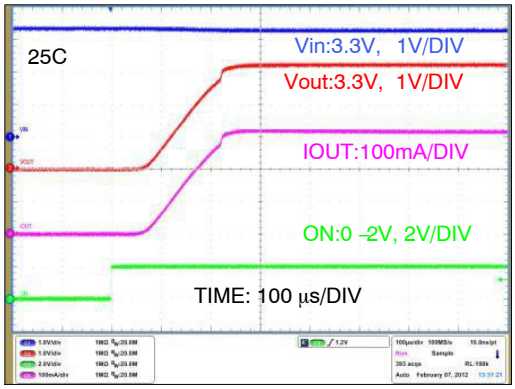


Figure 13. Turn−On Response
(V_{IN} = 3.3 V, C_{OUT} = 0.1 μF, R_L = 10 Ω)

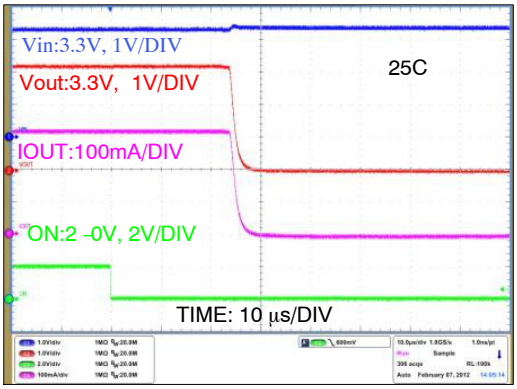


Figure 14. Turn−Off Response
(V_{IN} = 3.3 V, C_{OUT} = 0.1 μF, R_L = 10 Ω)

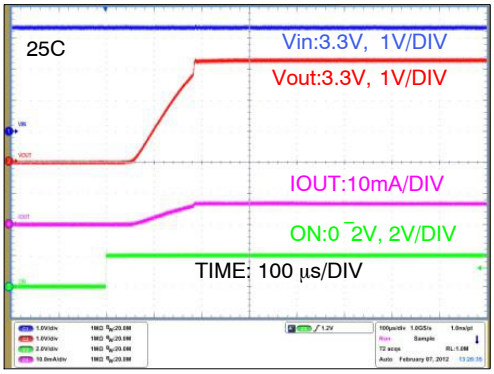


Figure 15. Turn−On Response
(V_{IN} = 3.3 V, C_{OUT} = 0.1 μF, R_L = 500 Ω)

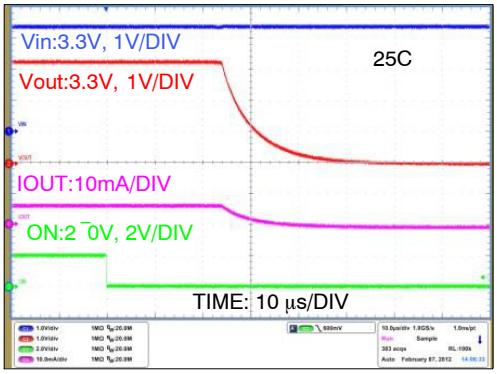


Figure 16. Turn−Off Response
(V_{IN} = 3.3 V, C_{OUT} = 0.1 μF, R_L = 500 Ω)

APPLICATION INFORMATION

Input Capacitor

IntelliMAX switches don't require an input capacitor. To reduce device inrush current, a 0.1 μF ceramic capacitor, C_{IN}, is recommended close to the VIN pin. A higher value of C_{IN} can be used to further reduce the voltage drop experienced as the switch is turned on into a large capacitive load.

Output Capacitor

IntelliMAX switches work without an output capacitor. If the applications parasitic board inductance forces V_{OUT} below GND when switching off, a 0.1 μF capacitor, C_{OUT}, should be placed between V_{OUT} and GND.

Fall Time

Device output fall time can be calculated based on RC constant of external components as follows:

$$t_F = R_L \times C_L \times 2.2 \quad \text{(eq. 1)}$$

where t_F is 90% to 10% fall time, R_L is output, load and C_L is output capacitor.

The same equation works for a device with a pull−down output resistor, then R_L is replaced by a parallel connected pull−down and external output resistor combination, as follows:

$$t_F = \frac{R_L \times R_{PD} \times C_L}{R_L + R_{PD}} \times 2.2 \quad \text{(eq. 2)}$$

where t_F is 90% to 10% fall time, R_L is output load, R_{PD} is output pull−down resistor (65 Ω typical), and C_L is the output capacitor.

RECOMMENDED LAND PATTERN AND LAYOUT

For best thermal performance and minimal inductance and parasitic effects, it is recommended to keep input and output traces short and the capacitors as close to the device as possible. Below is a recommended layout for this device to achieve optimum performance.

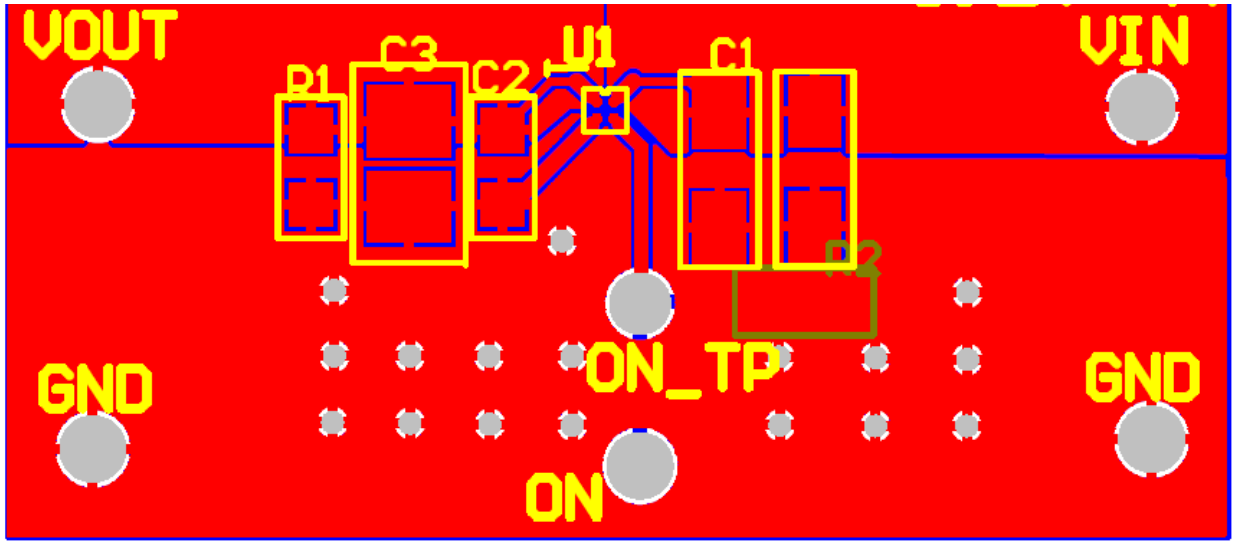


Figure 17. Recommended Land Pattern and Layout

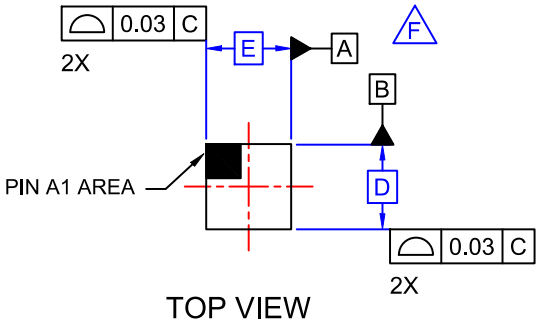
The following information applies to the WLCSP package dimensions on the next page:

PRODUCT−SPECIFIC DIMENSIONS

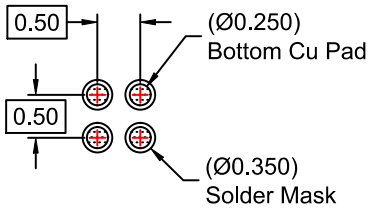
Product	D	E	X	Y
FPF1504UCX	960 μm ±30 μm	960 μm ±30 μm	0.230 mm	0.230 mm
FPF1504BUCX				
FPF1504LUCX				
FPF1504LBUCX				

WLCSP4 0.96x0.96x0.582
CASE 567RH
ISSUE O

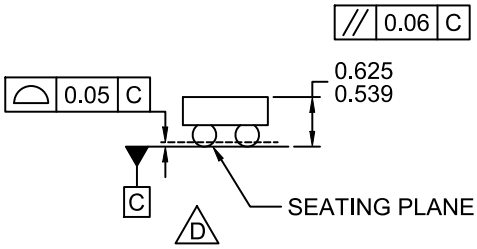
DATE 30 NOV 2016

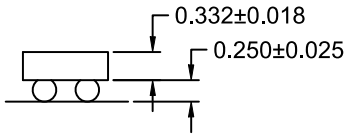


TOP VIEW

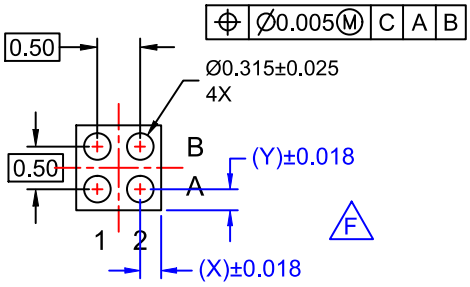


RECOMMENDED LAND PATTERN
(NSMD PAD TYPE)





SIDE VIEWS



BOTTOM VIEW

NOTES:

A. NO JEDEC REGISTRATION APPLIES.
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
D. DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
E. PACKAGE NOMINAL HEIGHT IS 582 MICRONS ±43 MICRONS (539-625 MICRONS).
F. FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.

DOCUMENT NUMBER:	**98AON16575G**	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	**WLCSP4 0.96x0.96x0.582**	**PAGE 1 OF 1**

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